

DFM800XXM45-TS001

Fast Recovery Diode Module

DS6096-3 February 2017 (LN34185)

FEATURES

Replaces DS6096-2

- 10.2kV Isolation Package
- Low Reverse Recovery Charge
- High Switching Speed
- Low Forward Volt Drop
- Isolated AISiC Base With AIN Substrates
- Dual Diodes Can Be Paralleled For 1600A Rating

APPLICATIONS

- **Chopper Diodes**
- **Boost and Buck Converters**
- Free-wheel Circuits
- **Snubber Circuit**
- **Resonant Converters**
- Induction Heating
- Multi-level Switch Inverters

The DFM800XXM45-TS001 is a dual 4500V, fast recovery diode (FRD) module. Designed for low power loss, the module is suitable for a variety of high voltage applications in motor drives and power conversion.

Fast switching times and low reverse recovery losses allow high frequency operation, making the device suitable for the latest drive designs employing PWM and high frequency switching.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DFM800XXM45-TS001

Note: When ordering, please use the complete part number

KEY PARAMETERS

V_{RRM}		4500V
V_{F}	(typ)	2.8V
I_{F}	(max)	A008
I _{FM}	(max)	1600A

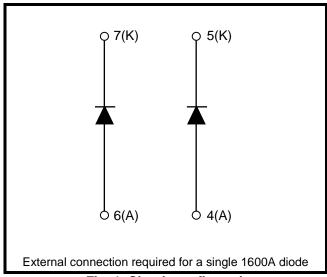


Fig. 1 Circuit configuration



Fig. 2 Package



ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
V_{RRM}	Repetitive peak reverse voltage	T _j = 125°C	4500	V
I _F	Forward current (per arm)	DC, T _{case} = 65°C	800	Α
I _{FM}	Max. forward current	$T_{case} = 115$ °C, $t_p = 1$ ms	1600	Α
l ² t	I ² t value fuse current rating	$V_R = 0$, $t_p = 10$ ms, $T_j = 125$ °C	300	kA ² s
P _{max}	Max. power dissipation	$T_{case} = 25^{\circ}C, T_{j} = 125^{\circ}C$	4160	W
V _{isol}	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	10.2	kV
Q_{PD}	Partial discharge – per module	IEC1287, $V_1 = 6900V$, $V_2 = 5100V$, 50Hz RMS	10	рC

THERMAL AND MECHANICAL RATINGS

Internal insulation material:

Baseplate material:

Creepage distance:

Clearance:

CTI (Comparative Tracking Index):

AIN

AISiC

56mm

26mm

> 600

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
R _{th(j-c)}	Thermal resistance (per arm)	Continuous dissipation – junction to case	-	-	24	°C/kW
R _{th(c-h)}	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	8	°C/kW
T_j	Junction temperature		-40	-	125	°C
T _{stg}	Storage temperature range		-40	-	125	°C
	Screw Torque	Mounting – M6	-	-	5	Nm
		Electrical connections – M8	-	-	10	Nm



STATIC ELECTRICAL CHARACTERISTICS - PER ARM

 T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
I _{RM}	Peak reverse current	V _R = 4500V, T _j = 125°C			60	mA
V _F	Forward voltage	I _F = 800A		2.8		V
		I _F = 800A, T _j = 125°C		3.2		V
L _M	Inductance	-		40		nΗ

DYNAMIC ELECTRICAL CHARACTERISTICS - PER ARM

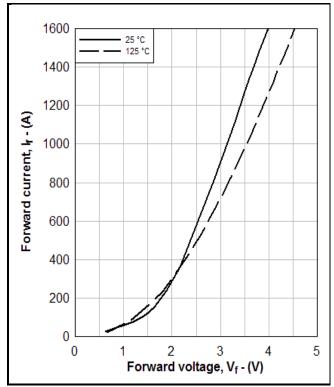
T_{case} = 25°C unless stated otherwise (when used with DIM800XSM45-TS001)

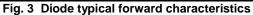
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
Q_{rr}	Reverse recovery charge	I _F = 800A		880		μC
I _{rr}	Peak reverse recovery current	V _R =2800V		680		Α
E _{rec}	Reverse recovery energy	$dI_{F}/dt = 2000/\mu s$		1480		mJ

T_{case} = 125°C unless stated otherwise (when used with DIM800XSM45-TS001)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
Q_{rr}	Reverse recovery charge	$I_F = 800A$ $V_R = 2800V$ $dI_F/dt = 2000A/\mu s$		1450		μC
I _{rr}	Peak reverse recovery current			750		Α
E _{rec}	Reverse recovery energy			2500		mJ







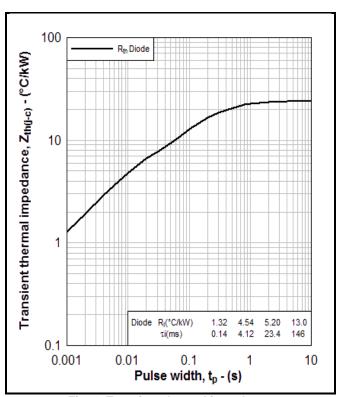


Fig. 4 Transient thermal impedance

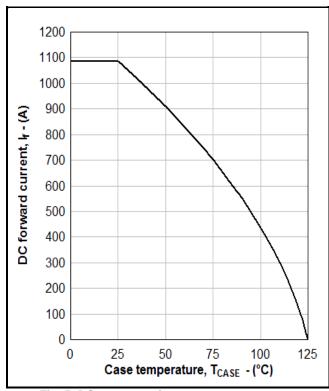


Fig. 5 DC current rating vs case temperature

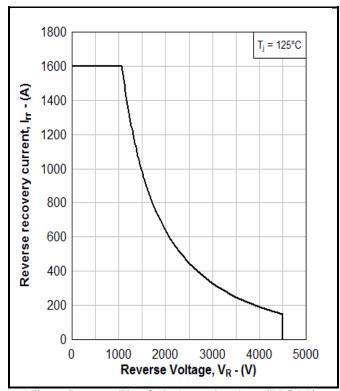


Fig. 6 Reverse Bias Safe Operating Area (RBSOA)



PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise.

DO NOT SCALE.

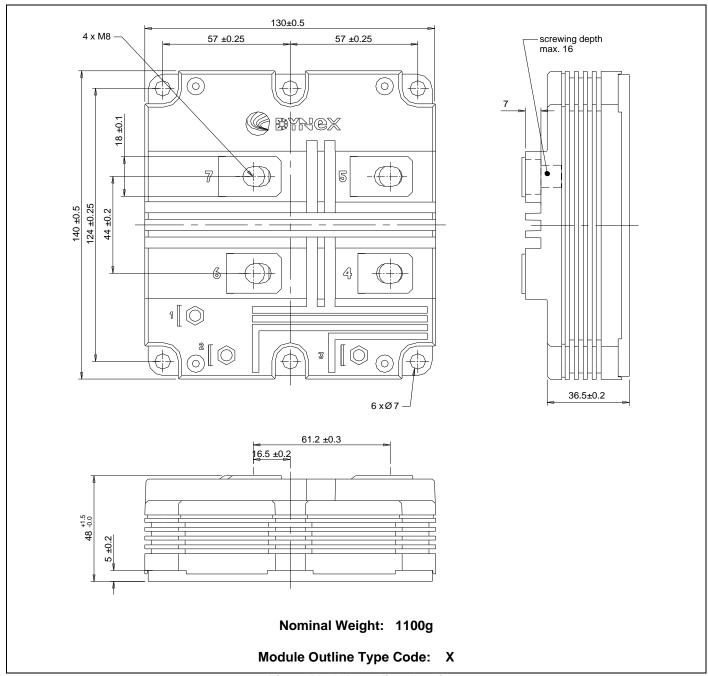


Fig. 7 Module outline drawing



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